



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Jun Koyama et al. Art Unit : 2871
Serial No. : 10/620,565 Examiner : Unknown
Filed : July 17, 2003
Title : SEMICONDUCTOR DEVICE AND MANUFACTURING METHOD THEREOF

MAIL STOP AMENDMENTS

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

INFORMATION DISCLOSURE STATEMENT

A copy of the non-patent reference listed on the attached form PTO-1449 is enclosed.

This statement is being filed before the receipt of a first Office Action on the merits.

Please apply any charges or credits to Deposit Account No. 06-1050.

Respectfully submitted,

Date: 10/22/04



John F. Hayden
Reg. No. 37,640

Customer No. 26171
Fish & Richardson P.C.
1425 K Street, N.W. - 11th Floor
Washington, DC 20005-3500
Telephone: (202) 783-5070
Facsimile: (202) 783-2331
JFH/adt
40249326.doc

Substitute Form PTO-1449
(Modified)U.S. Department of Commerce
Patent and Trademark OfficeAttorney's Docket No.
07977-209003Application No.
10/620,565**Information Disclosure Statement
by Applicant**

(Use several sheets if necessary)

Applicant
Jun Koyama et al.Filing Date
July 17, 2003Group Art Unit
2871**U.S. Patent Documents**

Examiner Initial	Desig. ID	Document Number	Publication Date	Patentee	Class	Subclass	Filing Date If Appropriate
	AA	5,182,620	01/26/1993	SHIMADA et al.			04/02/1991
	AB						
	AC						
	AD						
	AE						
	AF						
	AG						
	AH						
	AI						
	AJ						
	AK						

Foreign Patent Documents or Published Foreign Patent Applications

Examiner Initial	Desig. ID	Document Number	Publication Date	Country or Patent Office	Class	Subclass	Translation	
							Yes	No
	AL							
	AM							
	AN							
	AO							
	AP							

Other Documents (include Author, Title, Date, and Place of Publication)

Examiner Initial	Desig. ID	Document
	AQ	Office Action (Application No. 10/803,965), August 11, 2004, 7 pages.
	AR	
	AS	
	AT	

Examiner Signature

Date Considered

EXAMINER: Initials citation considered. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.